



CHENMKO ENTERPRISE CO.,LTD

SURFACE MOUNT

N-Channel Enhancement Mode Field Effect Transistor

VOLTAGE 60 Volts CURRENT 15 Ampere

CHM4060APAPT

Lead free devices

APPLICATION

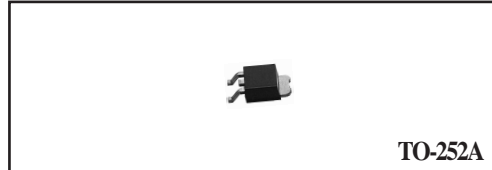
- * Servo motor control.
- * Power MOSFET gate drivers.
- * Other switching applications.

FEATURE

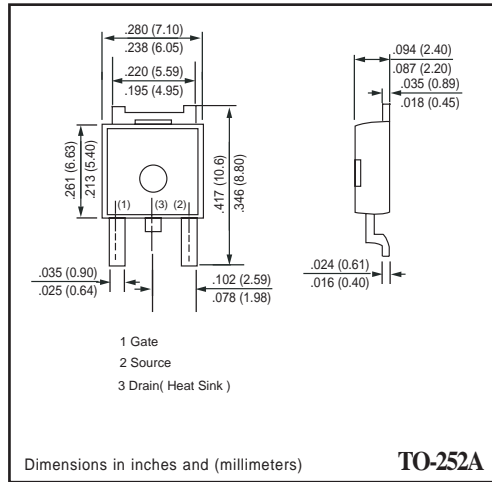
- * Small package. (TO-252A)
- * Super high dense cell design for extremely low R_{DS(ON)}.
- * High power and current handling capability.

CONSTRUCTION

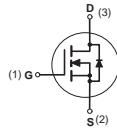
- * N-Channel Enhancement



TO-252A



CIRCUIT



Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter	CHM4060APAPT	Units
V _{DSS}	Drain-Source Voltage	60	V
V _{GSS}	Gate-Source Voltage	±20	V
I _D	Maximum Drain Current - Continuous	15	A
	- Pulsed (Note 3)	45	
P _D	Maximum Power Dissipation at T _c = 25°C	50	W
T _J	Operating Temperature Range	-55 to 150	°C
T _{STG}	Storage Temperature Range	-55 to 150	°C

- Note : 1. Surface Mounted on FR4 Board , t <=10sec
 2. Pulse Test , Pulse width <= 300us , Duty Cycle <= 2%
 3. Repetitive Rating , Pulse width limited by maximum junction temperature
 4. Guaranteed by design , not subject to production trsting

Thermal characteristics

R _{θJA}	Thermal Resistance, Junction-to-Ambient (Note 1)	50	°C/W
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RATING CHARACTERISTIC CURVES (CHM4060APAPT)

Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
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OFF CHARACTERISTICS

BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	60			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 60 V, V _{GS} = 0 V			25	μA
I _{GSSF}	Gate-Body Leakage	V _{GS} = 20V, V _{DS} = 0 V			+100	nA
I _{GSSR}	Gate-Body Leakage	V _{GS} = -20V, V _{DS} = 0 V			-100	nA

ON CHARACTERISTICS (Note 2)

V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA	2	2.7	4	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =7.5A		68	85	mΩ
g _{FS}	Forward Transconductance	V _{DS} =10V, I _D = 7.5A		6		S

SWITCHING CHARACTERISTICS (Note 4)

Q _g	Total Gate Charge	V _{DS} =48V, I _D =15A V _{GS} =10V		10	13	nC
Q _{gs}	Gate-Source Charge		2.4			
Q _{gd}	Gate-Drain Charge		4			
t _{on}	Turn-On Time	V _{DD} = 30V I _D =15A, V _{GS} = 10 V R _{GEN} = 25 Ω		10	20	nS
t _r	Rise Time		65	100		
t _{off}	Turn-Off Time		15	30		
t _f	Fall Time		30	50		

DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

I _S	Drain-Source Diode Forward Current				15	A
V _{SD}	Drain-Source Diode Forward Voltage	I _S = 7.5A, V _{GS} = 0 V		0.8	1.2	V